

# GS74LVC1G08 Series

## Single 2-Input AND Gate

### Product Description

The GS74LVC1G08 is designed for 1.65V to 5.5V V<sub>cc</sub> operation, performs the Boolean function Y=A • B.

Inputs can be driven from either 3.3V or 5V devices. This feature allows the use of this device in a mixed 3.3V and 5V system environment.

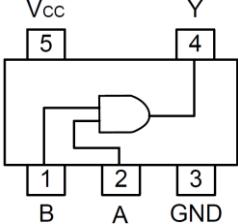
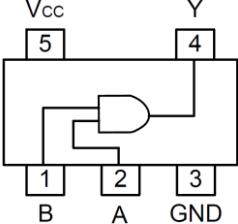
Schmitt trigger action at all inputs makes the circuit tolerant for slower input rise and fall time.

This device is fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing damaging backflow current through the device when it is powered down.

### Features

- Supports 1.65V to 5.5V V<sub>cc</sub> operation
- ±24mA output drive at V<sub>cc</sub>=3.0V
- CMOS low power consumption
- Direct interface with TTL levels
- Input accepts voltages up to 5V
- Latch-up performance exceeds 100mA
- RoHS Compliant and Halogen Free

### Package & Pin Assignment

GS74LVC1G08 Series (SOT-353)			
GS74LVC1G08LF (SOT-23-5L)			
		Y	
		V <sub>cc</sub>	
Pin	Pin Name	I/O	Description
1	B	I	Data input
2	A	I	Data input
3	GND	--	Ground (0V)
4	Y	O	Data output
5	V <sub>cc</sub>	--	Supply voltage

## Functional Block Diagram & Description

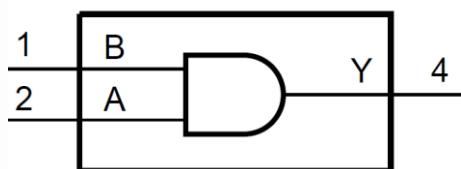


Fig 1. Function Diagram

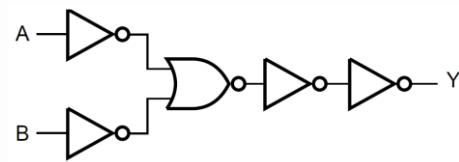
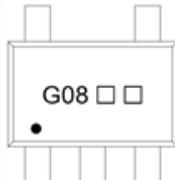


Fig 2. Logic Diagram

Input A	Input B	Output Y
L	L	L
L	H	L
H	L	L
H	H	H

H = HIGH voltage level;  
L = LOW voltage level.

## Ordering and Marking Information

Ordering Information			
Part Number	Package	Part Marking	Quantity / Reel
GS74LVC1G08LF	SOT-23-5L	G08□□	3,000 PCS
GS74LVC1G08JCF	SOT-353	G08□□	3,000 PCS
<b>GS74LVC1G08 1 2</b>			
- <b>Product</b> GS74LVC1G08	- <b>Package Code:</b> 1 is L or JC L is SOT-23-5L JC is SOT-353	- <b>Green Level:</b> 2 is F for RoHS Compliant and Halogen Free	
Marking Information			
 <ul style="list-style-type: none"> <li>- <b>Product Code:</b> G08</li> <li>- <b>GS Code:</b> □□</li> </ul>			

## Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise specified)

Characteristics	Symbol	Conditions	Min.	Max.	Unit
Supply voltage	V <sub>CC</sub>	--	-0.5	+6.5	V
Input voltage	V <sub>I</sub>	[1]	-0.5	+6.5	V
Input clamping current	I <sub>IK</sub>	V <sub>I</sub> <0V	-50	--	mA
Output clamping current	I <sub>OK</sub>	V <sub>O</sub> <0V or V <sub>O</sub> >V <sub>CC</sub>	-50	+50	mA
Output voltage	V <sub>O</sub>	Active mode [1]	-0.5	V <sub>CC</sub> +0.5	V
		Power-down mode [1]	-0.5	+6.5	V
Output current	I <sub>O</sub>	V <sub>O</sub> =0V to V <sub>CC</sub>	-50	+50	mA
Supply current	I <sub>CC</sub>	--	--	+100	mA
Ground current	I <sub>GND</sub>	--	-100	--	mA
Storage temperature	T <sub>STG</sub>	--	-65	+150	°C
Thermal Resistance Junction to Ambient	R <sub>thJA</sub>	SOT-23-5L	229		°C /W
		SOT-353	278		
Latch up	LU	T <sub>A</sub> =25°C, 125°C	100	--	mA

### NOTE

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## Recommended Operating Condition (T<sub>A</sub>=25°C unless otherwise specified)

(Voltages are referenced to GND (ground=0V))

Characteristics	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply Voltage	V <sub>CC</sub>	--	1.65	--	5.5	V
Input Voltage	V <sub>I</sub>	--	0	--	5.5	V
Output Voltage	V <sub>O</sub>	--	0	--	V <sub>CC</sub>	V
Ambient Temperature	T <sub>A</sub>		-40	+25	+125	°C
Input Transition rise and fall rate	Δt/ΔV	V <sub>CC</sub> =1.65V to 2.7V	--	--	20	ns/V
		V <sub>CC</sub> =2.7V to 5.5V	--	--	10	ns/V

## Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise specified)

### ■ Static Characteristics

(Voltages are referenced to GND (ground=0V))

Characteristics	Symbol	Test condition	-40°C to 85°C			-40°C to +125°C		Unit
			Min.	Typ. [1]	Max.	Min.	Max.	
High-level input voltage	$V_{IH}$	$V_{CC}=1.65\text{V to }1.95\text{V}$	0.65 $V_{CC}$	--	--	0.65 $V_{CC}$	--	V
		$V_{CC}=2.3\text{V to }2.7\text{V}$	1.7	--	--	1.7	--	V
		$V_{CC}=2.7\text{V to }3.6\text{V}$	2.0	--	--	2.0	--	V
		$V_{CC}=4.5\text{V to }5.5\text{V}$	0.7 $V_{CC}$	--	--	0.7 $V_{CC}$	--	V
Low-level input voltage	$V_{IL}$	$V_{CC}=1.65\text{V to }1.95\text{V}$	--	--	0.35 $V_{CC}$	--	0.35 $V_{CC}$	V
		$V_{CC}=2.3\text{V to }2.7\text{V}$	--	--	0.7	--	0.7	V
		$V_{CC}=2.7\text{V to }3.6\text{V}$	--	--	0.8	--	0.8	V
		$V_{CC}=4.5\text{V to }5.5\text{V}$	--	--	0.3 $V_{CC}$	--	0.3 $V_{CC}$	V
High-level output voltage	$V_{OH}$	$V_I=V_{IH}$ or $V_{IL}$						
		$I_O=-100\mu\text{A}; V_{CC}=1.65\text{V to }5.5\text{V}$	$V_{CC}-0.1$	--	--	$V_{CC}-0.1$	--	V
		$I_O=-4\text{mA}; V_{CC}=1.65\text{V}$	1.2	--	--	0.95	--	V
		$I_O=-8\text{mA}; V_{CC}=2.3\text{V}$	1.9	--	--	1.7	--	V
		$I_O=-12\text{mA}; V_{CC}=2.7\text{V}$	2.2	--	--	1.9	--	V
		$I_O=-24\text{mA}; V_{CC}=3.0\text{V}$	2.3	--	--	2.0	--	V
		$I_O=-32\text{mA}; V_{CC}=4.5\text{V}$	3.8	--	--	3.4	--	V
Low-level output voltage	$V_{OL}$	$V_I=V_{IH}$ or $V_{IL}$						
		$I_O=100\mu\text{A}; V_{CC}=1.65\text{V to }5.5\text{V}$	--	--	0.1	--	0.1	V
		$I_O=4\text{mA}; V_{CC}=1.65\text{V}$	--	--	0.45	--	0.7	V
		$I_O=8\text{mA}; V_{CC}=2.3\text{V}$	--	--	0.30	--	0.45	V
		$I_O=12\text{mA}; V_{CC}=2.7\text{V}$	--	--	0.40	--	0.60	V
		$I_O=24\text{mA}; V_{CC}=3.0\text{V}$	--	--	0.55	--	0.80	V
		$I_O=32\text{mA}; V_{CC}=4.5\text{V}$	--	--	0.55	--	0.80	V
Input leakage current	$I_I$	$V_I=5.5\text{V or GND}; V_{CC}=0\text{V to }5.5\text{V}$	--	$\pm 0.1$	$\pm 1.0$	--	$\pm 1.0$	$\mu\text{A}$
Power-off leakage current	$I_{OFF}$	$V_{CC}=0\text{V}; V_I$ or $V_O=5.5\text{V}$	--	$\pm 0.1$	$\pm 2.0$	--	$\pm 2.0$	$\mu\text{A}$
Supply current	$I_{CC}$	$V_I=5.5\text{V or GND}; I_O=0\text{A}; V_{CC}=1.65\text{V to }5.5\text{V}$	--	0.1	4.0	--	4.0	$\mu\text{A}$
Additional supply current	$\Delta I_{CC}$	$V_{CC}=2.3\text{V to }5.5\text{V} V_I=V_{CC}=-0.6\text{V}; I_O=0\text{A}; \text{Per input pin;}$	--	5	500	--	500	$\mu\text{A}$
Input capacitance	$C_I$	--	--	5	--	--	--	$\text{pF}$

#### NOTE

1.Typical values are measured at  $V_{CC}=3.3\text{V}$  and  $T_A=25^\circ\text{C}$ .

## ■ Dynamic Characteristics

(GND=0V. for test circuit see Fig.4)

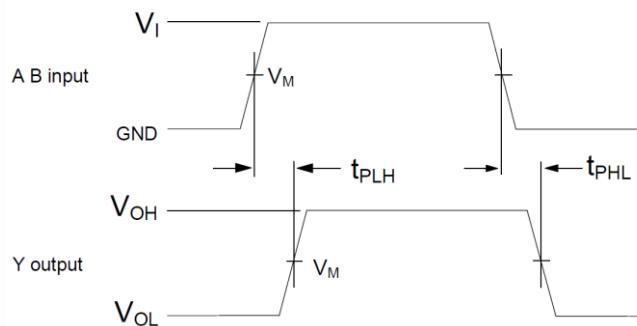
Characteristics	Symbol	Test condition	-40°C to 85°C			-40°C to +125°C			Unit
			Min.	Typ. <sup>[1]</sup>	Max.	Min.	Max.		
Propagation delay	$t_{pd}$	A, B to Y; see Fig.3 <sup>[2]</sup>							
		$V_{CC}=1.65V$ to $1.95V$	1.0	5.2	10.8	1.0	13.2	ns	
		$V_{CC}=2.3V$ to $2.7V$	0.5	3.0	7.5	0.5	9.0	ns	
		$V_{CC}=2.7V$	0.5	3.5	8.4	0.5	9.8	ns	
		$V_{CC}=3.0V$ to $3.6V$	0.5	2.6	6.2	0.5	7.5	ns	
		$V_{CC}=4.5V$ to $5.5V$	0.5	2.2	5.4	0.5	6.3	ns	

### NOTE

1. Typical values are measured at  $V_{CC}=3.3V$  and  $T_A=25^\circ C$ .

2.  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

## Waveforms and Test Circuit

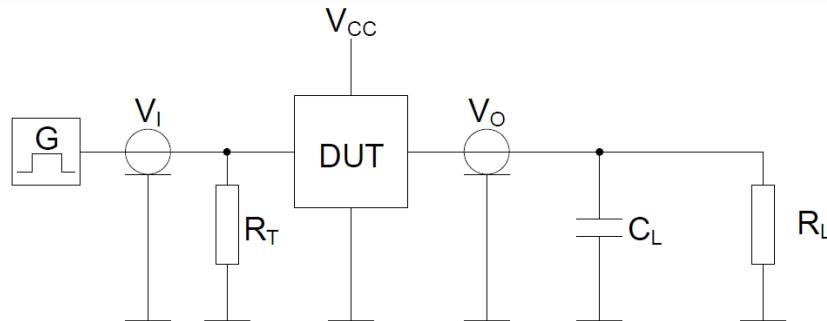
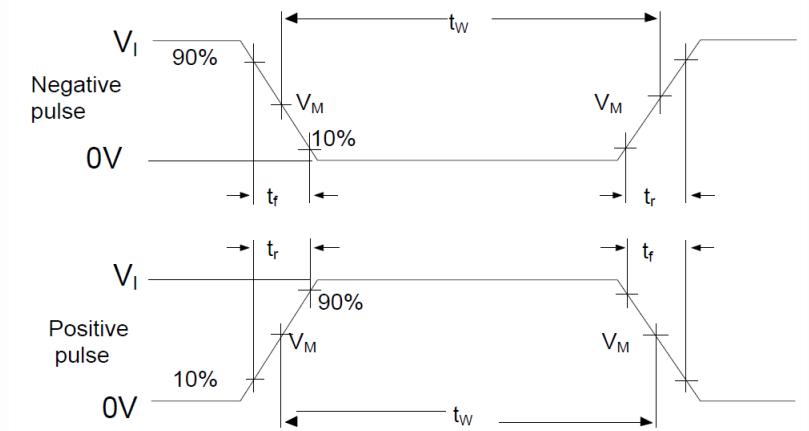


$V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

Fig 3. Propagation delay input (A, B) to output (Y)

## ■ Measurement Points

Supply voltage	Input	Output
	$V_M$	$V_M$
1.65V to 1.95V	0.5 $V_{CC}$	0.5 $V_{CC}$
2.3V to 2.7V	0.5 $V_{CC}$	0.5 $V_{CC}$
2.7V	1.5V	1.5V
3.0V to 3.6V	1.5V	1.5V
4.5V to 5.5V	0.5 $V_{CC}$	0.5 $V_{CC}$



**Fig 4. Test circuit for measuring switching times**

Definitions test circuit :

$R_T$ = Termination resistance should be equal to output impedance  $Z_O$  of the pulse generator

$C_L$ = Load capacitance including jig and probe capacitance

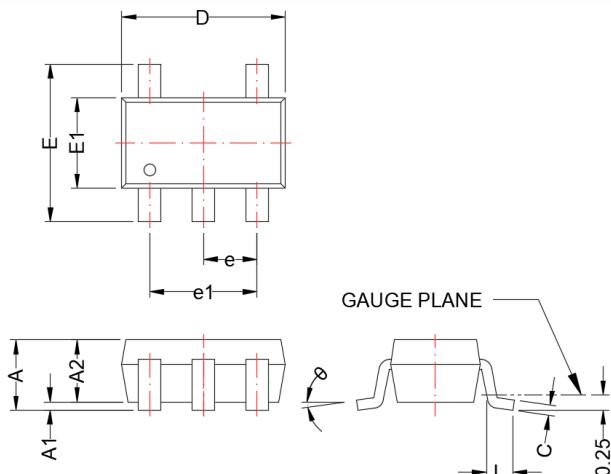
$R_L$ = Load resistor

#### ■ Test Data

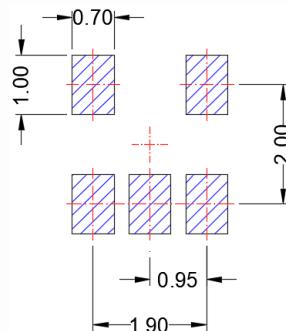
Supply voltage	Input		Load	
	$V_I$	$t_r, t_f$	$C_L$	$R_L$
1.65V to 1.95V	VCC	$\leq 3.0\text{ns}$	30pF	1k $\Omega$
2.3V to 2.7V	VCC	$\leq 3.0\text{ns}$	30pF	500 $\Omega$
2.7V	2.7V	$\leq 3.0\text{ns}$	50pF	500 $\Omega$
3.0V to 3.6V	2.7V	$\leq 3.0\text{ns}$	50pF	500 $\Omega$
4.5V to 5.5V	VCC	$\leq 3.0\text{ns}$	50pF	500 $\Omega$

# SOT-23-5L

## Package Dimension



## Recommended Land Pattern



## Dimensions

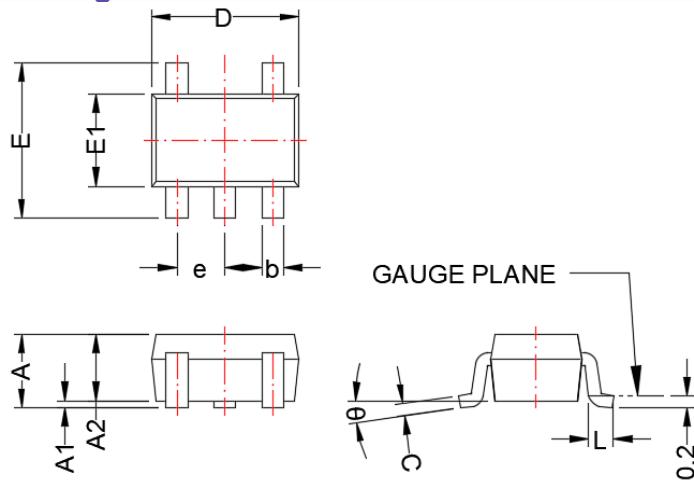
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.90	1.45	0.035	0.057
A1	0.00	0.15	0.000	0.006
A2	0.90	1.30	0.035	0.051
b	0.30	0.50	0.012	0.020
c	0.08	0.26	0.003	0.010
D	2.70	3.10	0.106	0.122
E	2.20	3.00	0.087	0.118
E1	1.30	1.75	0.051	0.069
e	0.95 BSC		0.037 BSC	
e1	1.90 BSC		0.075 BSC	
L	0.30	0.60	0.012	0.024
$\theta$	0°	8°	0°	8°

**NOTE:**

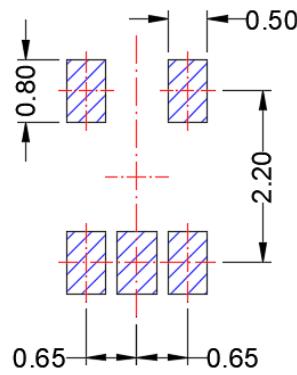
Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

# SOT-353

## Package Dimension



## Recommended Land Pattern



## Dimensions

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	---	1.10	---	0.043
A1	0.00	0.10	0.000	0.004
A2	0.70	1.00	0.028	0.039
b	0.15	0.35	0.006	0.014
c	0.08	0.25	0.003	0.010
D	1.80	2.20	0.071	0.087
E	1.80	2.45	0.071	0.096
E1	1.15	1.35	0.045	0.053
e	0.65 BSC		0.026 BSC	
L	0.26	0.46	0.010	0.018
$\theta$	0°	8°	0°	8°

### NOTE:

Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

## NOTICE

- Globaltech Semiconductor assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all Globaltech Semiconductor products described or contained herein. Globaltech Semiconductor products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.
- Applications shown on the herein document are examples of standard use and operation. Customers are responsible in comprehending the suitable use in particular applications. Globaltech Semiconductor makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.
- Information furnished is believed to be accurate and reliable. However Globaltech Semiconductor assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties, which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Globaltech Semiconductor. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information without express written approval of Globaltech Semiconductor.

## CONTACT US

GS Headquarter	
	4F, NO.43-1, Lane 11, Sec. 6, Minquan E. Rd Neihu District, Taipei City 114761, Taiwan(R.O.C).
	886-2-2657-9980
	886-2-2657-3630
	<a href="mailto:sales_twn@gs-power.com">sales_twn@gs-power.com</a>

RD Division	
	824 Bolton Drive Milpitas. CA. 95035
	1-408-457-0587